

PS9905

 $2.5\,\mathrm{A}$ OUTPUT CURRENT, HIGH CMR, IGBT GATE DRIVE, 8-PIN LSDIP PHOTOCOUPLER FOR CREEPAGE DISTANCE OF $14.5\,\mathrm{mm}$

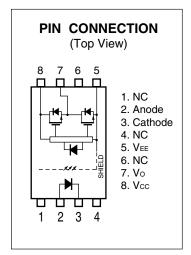
R08DS0058EJ0100 Rev.1.00 Jun 11, 2012

DESCRIPTION

The PS9905 is optically coupled isolator containing a GaAlAs LED on the input side and a photo diode, a signal processing circuit and a power output transistor on the output side on one chip.

FEATURES

- Long creepage distance (14.5 mm MIN.)
- Large peak output current (2.5 A MAX., 2.0 A MIN.)
- High speed switching (t_{PLH} , $t_{PHL} = 0.15 \,\mu s \, MAX$.)
- UVLO (Under Voltage Lock Out) protection with hysteresis
- High common mode transient immunity (CM_H, CM_L = $\pm 25 \text{ kV/}\mu\text{s}$ MIN.)
- 8-pin LSDIP (Long Creepage SDIP) type
- Embossed tape product: PS9905-F3: 1 000 pcs/reel
- Pb-Free Product
- · Safety standards
 - UL approved: No. E72422
 - CSA approved: No. CA 101391 (CA5A, CAN/CSA-C22.2 60065, 60950)
 - SEMKO approved: No. 1122994
 - DIN EN60747-5-5 (VDE0884-5): 2011-11 approved: No. 40034588 (Option)

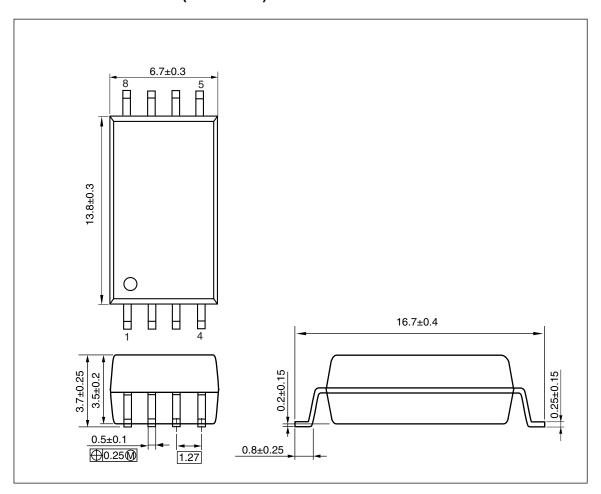


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APPLICATIONS

- IGBT, Power MOS FET Gate Driver
- Industrial inverter
- Solar inverter

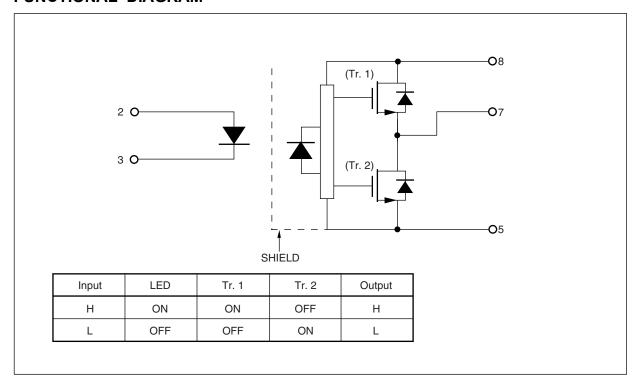
PACKAGE DIMENSIONS (UNIT: mm)



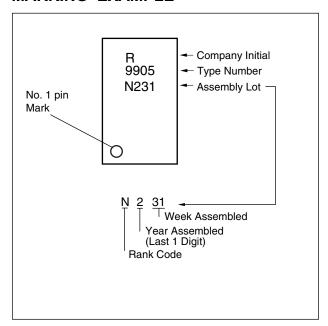
PHOTOCOUPLER CONSTRUCTION

Parameter	Unit (MIN.)
Air Distance	14.5 mm
Outer Creepage Distance	14.5 mm
Isolation Distance	0.4 mm

FUNCTIONAL DIAGRAM



MARKING EXAMPLE



<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS9905	PS9905-Y-AX	Pb-Free	10 pcs (Tape 10 pcs cut)	Standard products	PS9905
PS9905-F3	PS9905-Y-F3-AX	(Ni/Pd/Au)	Embossed Tape 1 000	(UL, CSA, SEMKO	
			pcs/reel	approved)	
PS9905-V	PS9905-Y-V-AX		10 pcs (Tape 10 pcs cut)	DIN EN60747-5-5	
PS9905-V-F3	PS9905-Y-V-F3-AX		Embossed Tape 1 000	(VDE0884-5):	
			pcs/reel	2011-11	
				approved (Option)	

Note: *1. For the application of the Safety Standard, following part number should be used.

<R> ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current	I _F	25	mA
Peak Transient Forward Current (Pulse Width < 1 μs)		I _{F (TRAN)}	1.0	А
	Reverse Voltage	V_R	5	V
	Power Dissipation*1,*6	P _D	45	mW
Detector	High Level Peak Output Current*2	I _{OH (PEAK)}	2.5	А
	Low Level Peak Output Current*2	I _{OL (PEAK)}	2.5	А
	Supply Voltage	(V _{CC} - V _{EE})	0 to 35	V
	Output Voltage	Vo	0 to V _{CC}	V
Power Dissipation*3,*6		Pc	250	mW
Isolation Voltage *4		BV	7 500	Vr.m.s.
Operating Frequency *5		f	50	kHz
Operating Ambient Temperature		T _A	-40 to +110	°C
Storage Temperature		T _{stg}	-55 to +125	°C

Notes: *1. Derating to be set after 0.8 mW/ $^{\circ}$ C at T_A = 85 $^{\circ}$ C or more.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	(V _{CC} - V _{EE})	15		30	V
Forward Current (ON)	I _{F (ON)}	10	12	14	mA
Forward Voltage (OFF)	V _{F (OFF)}	-2		0.8	V
Operating Ambient Temperature	T _A	-40		110	°C

^{*2.} Maximum pulse width = 10 μ s, Maximum duty cycle = 0.2 %

^{*3.} Reduced to 5.2 mW/ $^{\circ}$ C at T_A = 85 $^{\circ}$ C or more

^{*4.} AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output. Pins 1-4 shorted together, 5-8 shorted together.

^{*5.} $I_{OH (PEAK)} \le 2.0 \text{ A } (\le 0.3 \ \mu\text{s}), \ I_{OL (PEAK)} \le 2.0 \text{ A } (\le 0.3 \ \mu\text{s})$

^{*6.} Mounted on glass epoxy substrate of 75 mm \times 115 mm \times t1.5 mm

ELECTRICAL CHARACTERISTICS

(V_{EE} = GND, unless otherwise specified and refer to RECOMMENDED OPERATING CONDITIONS)

Parameter		Symbol	Conditions	MIN.	TYP.*1	MAX.	Unit
Diode	Forward Voltage	V _F	I _F = 10 mA, T _A = 25°C	1.3	1.56	1.8	V
	Reverse Current	I _R	V _R = 3 V, T _A = 25°C			10	μΑ
	Terminal Capacitance	Ct	$f = 1 \text{ MHz}, V_F = 0 \text{ V}, T_A = 25^{\circ}\text{C}$		30		pF
Detector	High Level Output Current	I _{OH}	$V_{\rm O} = (V_{\rm CC} - 4 V)^{*2}$	0.5	2.0		Α
			$V_{\rm O} = (V_{\rm CC} - 15 \text{ V})^{*3}$	2.0			
	Low Level Output Current	I _{OL}	$V_{\rm O} = (V_{\rm EE} + 2.5 \rm V)^{*2}$	0.5	2.0		Α
			$V_{O} = (V_{EE} + 15 \text{ V})^{*3}$	2.0			
	High Level Output Voltage	V _{OH}	$I_{\rm O} = -100 \text{ mA}^{*4}$	V _{CC} - 3.0	V _{CC} – 1.5		V
	Low Level Output Voltage	V _{OL}	I _O = 100 mA		0.1	0.5	V
	High Level Supply Current	Іссн	V _O = open, I _F = 12 mA		1.4	3.0	mA
	Low Level Supply Current	I _{CCL}	$V_{\rm O}$ = open, $V_{\rm F}$ = -2 to +0.8 V		1.3	3.0	mA
	UVLO Threshold	V _{UVLO+}	V _O > 5 V, I _F = 12 mA	10.8	12.3	13.4	V
		V _{UVLO} _		9.5	11.0	12.5	
	UVLO Hysteresis	UVLO _{HYS}	V _O > 5 V, I _F = 12 mA	0.4	1.3		V
Coupled	Threshold Input Current	I _{FLH}	I _O = 0 mA, V _O > 5 V		2.9	6.0	mA
	$(L \rightarrow H)$						
	Threshold Input Voltage	V_{FHL}	$I_0 = 0 \text{ mA}, V_0 < 5 \text{ V}$	0.8		·	V
	$(H \rightarrow L)$						

Notes: *1. Typical values at T_A = 25°C

^{*2.} Maximum pulse width = 50 μ s, Maximum duty cycle = 0.5%.

^{*3.} Maximum pulse width = 10 μ s, Maximum duty cycle = 0.2%.

^{*4.} V_{OH} is measured with the DC load current in this testing (Maximum pulse width = 2 ms, Maximum duty cycle = 20%).

<R> SWITCHING CHARACTERISTICS

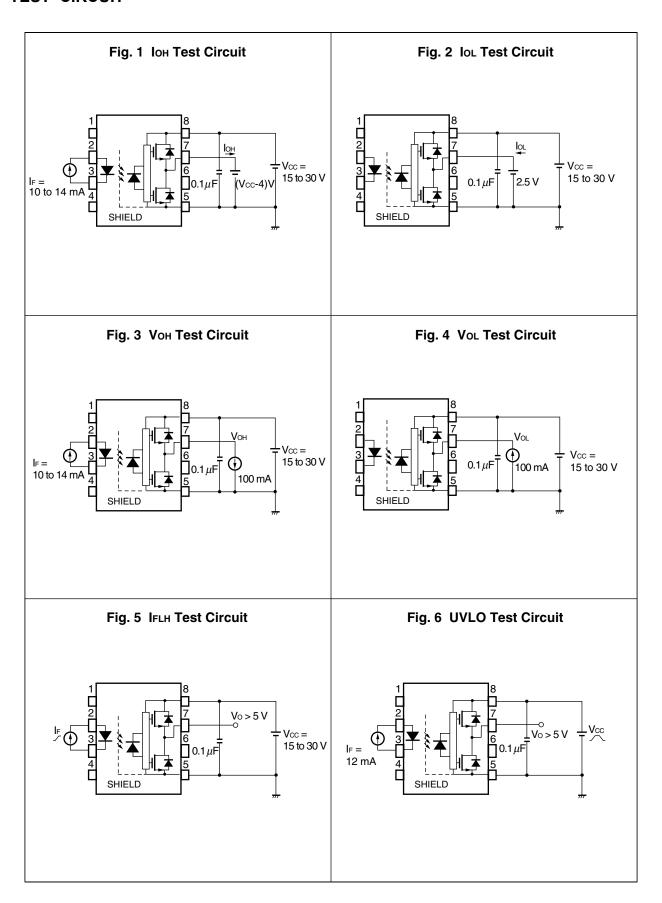
(V_{EE} = GND, unless otherwise specified and refer to RECOMMENDED OPERATING CONDITIONS)

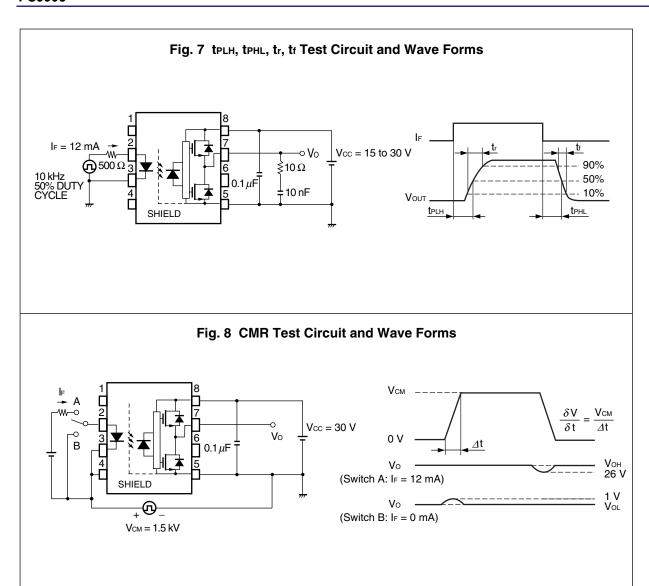
Parameter	Symbol	Conditions	MIN.	TYP.*1	MAX.	Unit
Propagation Delay Time $(L \rightarrow H)$	t _{PLH}	$R_g = 10 \Omega$, $C_g = 10 \text{ nF}^{*2}$, $f = 10 \text{ kHz}$,		0.09	0.15	μS
Propagation Delay Time $(H \rightarrow L)$	t _{PHL}	Duty Cycle = 50%, I _F = 12 mA		0.1	0.15	μs
Pulse Width Distortion (PWD)	t _{PHL} -t _{PLH}			0.01	0.075	μs
Propagation Delay Time	t _{PHL} —t _{PLH}		-0.1		0.1	μs
(Difference Between Any Two						
Products)						
Rise Time	t _r			50		ns
Fall Time	t _f			50		ns
UVLO (Turn On Delay)	t _{UVLO ON}	V _O > 5 V, I _F = 12 mA		8.0		μs
UVLO (Turn Off Delay)	tuvlo off	V _O < 5 V, I _F = 12 mA		0.6		μs
Common Mode Transient	CM _H	$T_A = 25^{\circ}C$, $I_F = 12$ mA, $V_{CC} = 30$ V,	25			kV/μs
Immunity at High Level Output		$V_{O (MIN.)} = 26 \text{ V}, V_{CM} = 1.5 \text{ kV}$				
Common Mode Transient	CM _L	$T_A = 25^{\circ}C$, $I_F = 0$ mA, $V_{CC} = 30$ V,	25			kV/ <i>μ</i> s
Immunity at Low Level Output		$V_{O (MAX.)} = 1 V, V_{CM} = 1.5 kV$				

Notes: *1. Typical values at $T_A = 25^{\circ}C$

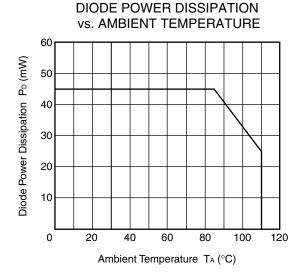
 $^{^{\}star}2$. This load condition is equivalent to the IGBT load at 1 200 V / 75 A.

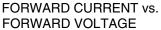
<R> TEST CIRCUIT

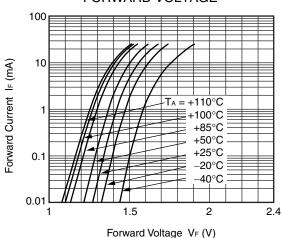




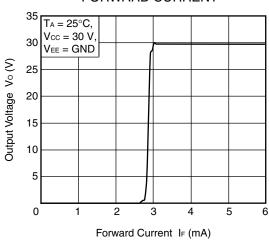
<R> TYPICAL CHARACTERISTICS (T_A = 25°C, unless otherwise specified)



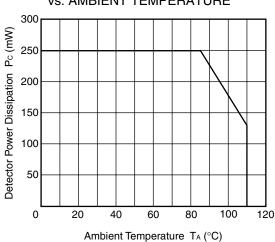




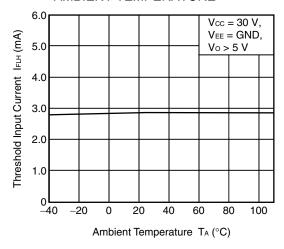
OUTPUT VOLTAGE vs. FORWARD CURRENT



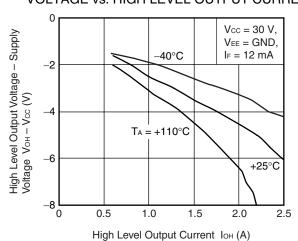
DETECTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE

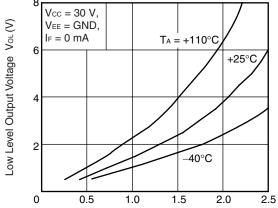


HIGH LEVEL OUTPUT VOLTAGE – SUPPLY VOLTAGE vs. HIGH LEVEL OUTPUT CURRENT



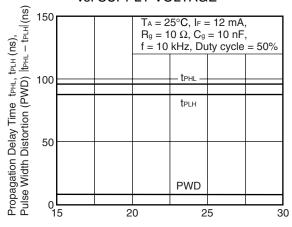
Remark The graphs indicate nominal characteristics.

LOW LEVEL OUTPUT VOLTAGE vs. LOW LEVEL OUTPUT CURRENT



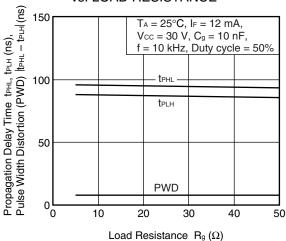
PROPAGATION DELAY TIME, PULSE WIDTH DISTORTION vs. SUPPLY VOLTAGE

Low Level Output Current loL (A)

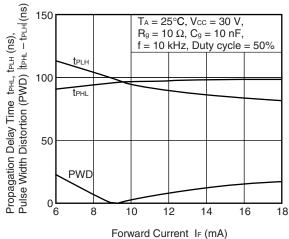


PROPAGATION DELAY TIME, PULSE WIDTH DISTORTION vs. LOAD RESISTANCE

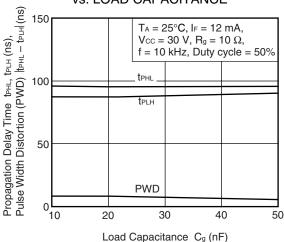
Supply Voltage Vcc (V)



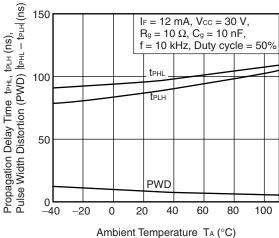
PROPAGATION DELAY TIME, PULSE WIDTH DISTORTION vs. FORWARD CURRENT



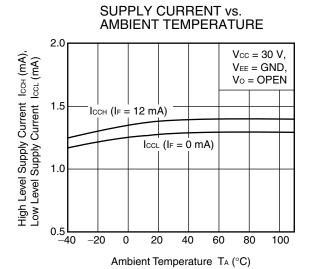
PROPAGATION DELAY TIME, PULSE WIDTH DISTORTION vs. LOAD CAPACITANCE



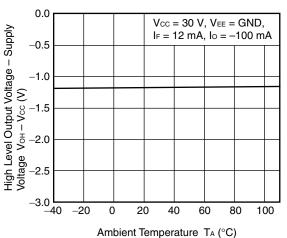
PROPAGATION DELAY TIME, PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE



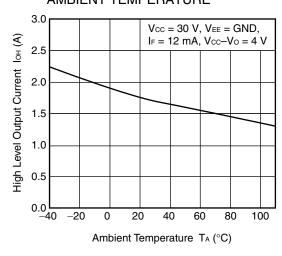
Remark The graphs indicate nominal characteristics.



HIGH LEVEL OUTPUT VOLTAGE – SUPPLY VOLTAGE vs. AMBIENT TEMPERATURE

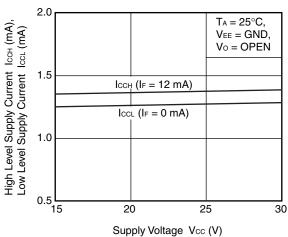


HIGH LEVEL OUTPUT CURRENT vs. AMBIENT TEMPERATURE

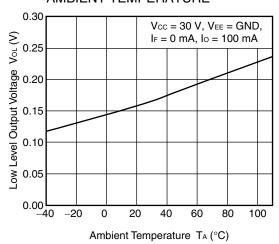


Remark The graphs indicate nominal characteristics.

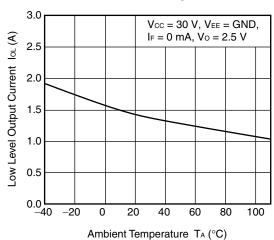
SUPPLY CURRENT vs. SUPPLY VOLTAGE



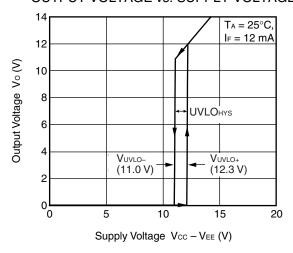
LOW LEVEL OUTPUT VOLTAGE vs. AMBIENT TEMPERATURE



LOW LEVEL OUTPUT CURRENT vs. AMBIENT TEMPERATURE

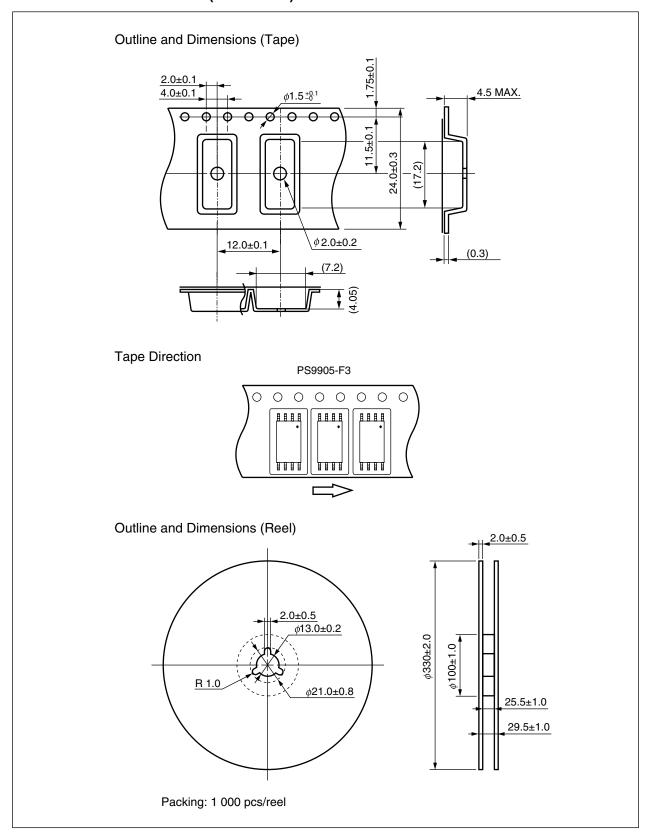


OUTPUT VOLTAGE vs. SUPPLY VOLTAGE

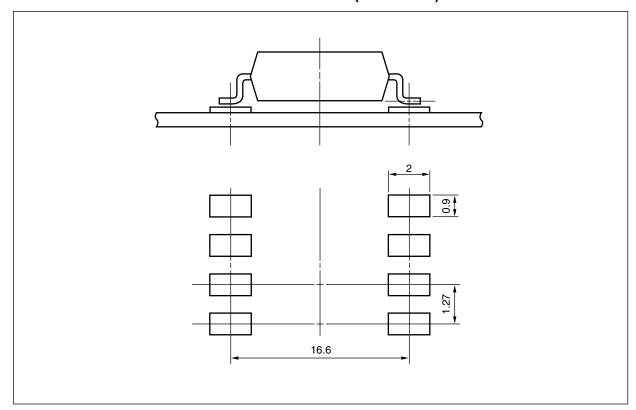


Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)



RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

• Peak reflow temperature 260°C or below (package surface temperature)

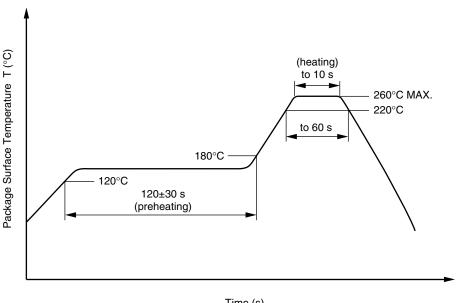
• Time of peak reflow temperature 10 seconds or less • Time of temperature higher than 220°C 60 seconds or less

• Time to preheat temperature from 120 to 180°C 120±30 s · Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

• Preheating conditions 120°C or below (package surface temperature)

• Number of times One (Allowed to be dipped in solder including plastic mold portion.)

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2

Wt% is recommended.)

(3) Soldering by Soldering Iron

350°C or below • Peak Temperature (lead part temperature) • Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum

chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. Board designing
 - (1) By-pass capacitor of more than 0.1 μ F is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
 - (2) When designing the printed wiring board, ensure that the pattern of the IGBT collectors/emitters is not too close to the input block pattern of the photocoupler.
 - If the pattern is too close to the input block and coupling occurs, a sudden fluctuation in the voltage on the IGBT output side might affect the photocoupler's LED input, leading to malfunction or degradation of characteristics.
 - (If the pattern needs to be close to the input block, to prevent the LED from lighting during the off state due to the abovementioned coupling, design the input-side circuit so that the bias of the LED is reversed, within the range of the recommended operating conditions, and be sure to thoroughly evaluate operation.)
 - (3) Pin 1, 4 (which is an NC*1 pin) can either be connected directly to the GND pin on the LED side or left open. Also, Pin 6 (which is an NC*1 pin) can either be connected directly to the GND pin on the detector side or left open. Unconnected pins should not be used as a bypass for signals or for any other similar purpose because this may degrade the internal noise environment of the device.

Note: *1. NC: Non-Connection (No Connection)

- 3. Make sure the rise/fall time of the forward current is 0.5 μ s or less.
- 4. In order to avoid malfunctions, make sure the rise/fall slope of the supply voltage is 3 V/ μ s or less.
- 5. Avoid storage at a high temperature and high humidity.

<R> SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Spec.	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		40/110/21	
Dielectric strength			
maximum operating isolation voltage	U_IORM	1 600	V_{peak}
Test voltage (partial discharge test, procedure a for type test and random test)	U_pr	2 560	V_{peak}
$U_{pr} = 1.6 \times U_{IORM.}, P_d < 5 pC$			
Test voltage (partial discharge test, procedure b for all devices)	U_pr	3 000	V_{peak}
$U_{pr} = 1.875 \times U_{IORM.}, P_d < 5 pC$			
Highest permissible overvoltage	U_TR	12 000	V_{peak}
Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303 Part 11))	CTI	175	
Material group (DIN EN 60664-1 VDE0110 Part 1)		III a	
Storage temperature range	T_{stg}	-55 to +125	°C
Operating temperature range	T_A	-40 to +110	°C
Isolation resistance, minimum value			
$V_{IO} = 500 \text{ V dc at T}_{A} = 25^{\circ}\text{C}$	Ris MIN.	10 ¹²	Ω
V _{IO} = 500 V dc at T _A MAX. at least 100°C	Ris MIN.	10 ¹¹	Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal			
derating curve)			
Package temperature	Tsi	175	°C
Current (input current I _F , Psi = 0)	Isi	400	mA
Power (output or total power dissipation)	Psi	700	mW
Isolation resistance			
V_{IO} = 500 V dc at T_A = Tsi	Ris MIN.	10 ⁹	Ω

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

Revision History

PS9905 Data Sheet

		Description		
Rev.	Date	Page	Summary	
0.01	Apr 06, 2012	_	First edition issued	
1.00	Jun 11, 2012	Throughout	Preliminary Data Sheet → Data Sheet	
		p.1	Modification of FEATURES	
		p.4	Modification of ORDERING INFORMATION	
		p.5	Modification of ABSOLUTE MAXIMUM RATINGS	
		p.6	Modification of SWITCHING CHARACTERISTICS	
		pp.7, 8	Modification of TEST CIRCUIT	
		pp.9 to 12	Addition of TYPICAL CHARACTERISTICS	
		p.17	Addition of SPECIFICATION OF VDE MARKS LICENSE DOCUMENT	

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